

# **MINIATURE SIGNAL RELAY EC2/EE2 SERIES**

### **COMPACT SIZE, SLIM-PACKAGE**

#### DESCRIPTION

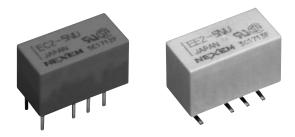
NEXEM EC2/EE2 relay is a standard miniature signal relay, compact and slim.

#### **FEATURES**

- Compact and light weight
- $\Box$  FCC (1500 V) and Telcordia (2500 V) surge capacity
- UL recognized and CSA certified.
- Low power consumption (100-200 mW)
- □ ND type (High insulation) conform to supplement insulation for EN60950
- NKX type (High breakdown voltage) can withstand 1.5KVAC at open contacts

#### **APPLICATIONS**

Electronic switching systems, PBX, Terminal equipment, Telephone system



#### For Right Use of Miniature Relays

#### DO NOT EXCEED MAXIMUM RATINGS.

Do not use relays under exceeding conditions such as over ambient temperature, over voltage and over current. Incorrect use could result in abnormal heating, damage to related parts or cause burning.

#### READ CAUTIONS IN THE SELECTION GUIDE.

Read the cautions described in EM Devices' "Miniature Relays" when you choose relays for your application.

The information in this document is subject to change without notice.

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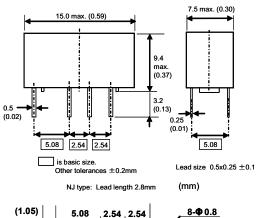
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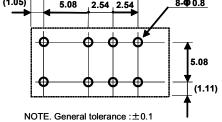


### DIMENSIONS AND PAD LAYOUTS Unit: mm (inch)

#### EC2 SERIES

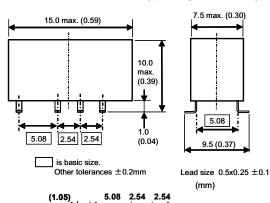
Non-latch type, Single coil latch type

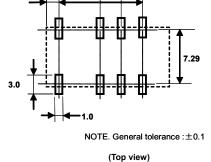


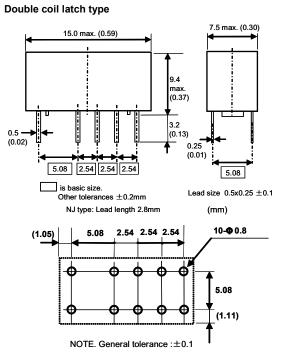


(Bottom view)

EE2 SERIES Standard/ Non-latch type, Single coil latch type

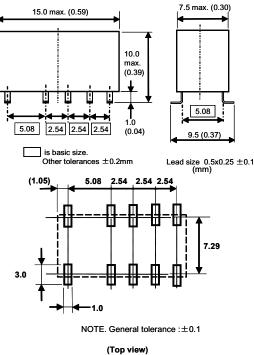






(Bottom view)

Standard/ Double coil latch type





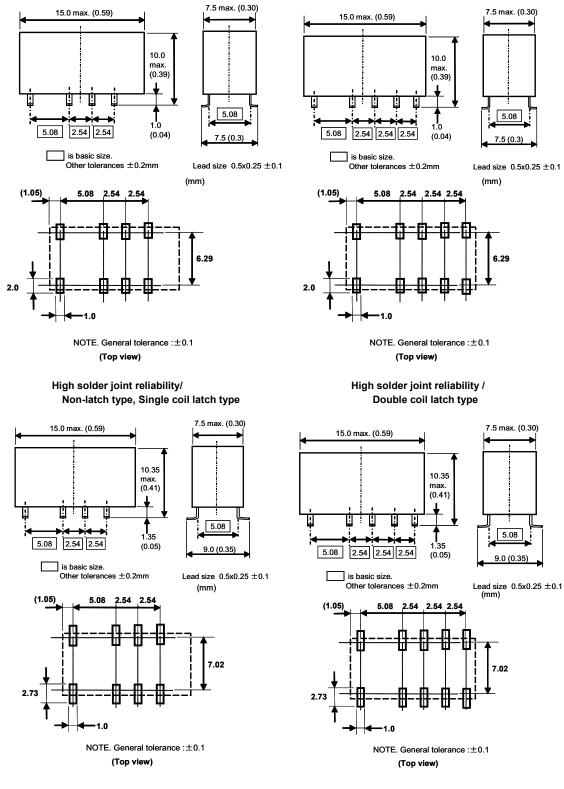
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Minimum footprint / Non-latch type, Single coil latch type

Minimum footprint/ Double coil latch type

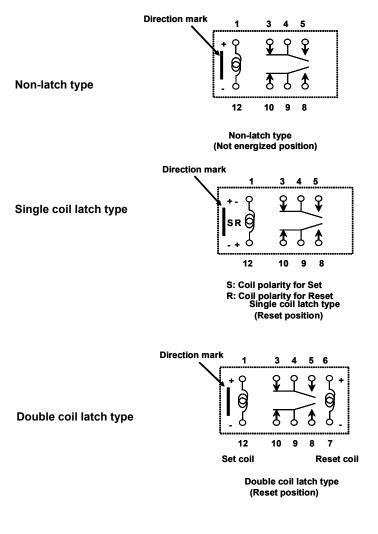


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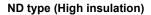
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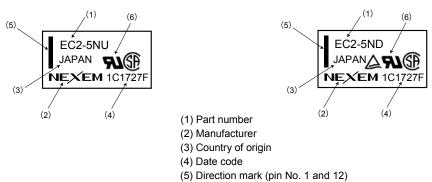
#### PIN CONFIGURATIONS (Bottom view)



#### MARKINGS (top view)

Except ND type





(6) UL,CSA marking (TUV added for ND type)

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### **GENERAL SPECIFICATIONS**

Contact Form		2 Form C	
Contact Material		Silver alloy with gold alloy overlay	
	Maximum Switching Power	60 W, 62.5VA (resistive)	
Contact Ratings	Maximum Switching Voltage	220 VDC, 250 VAC	
	Maximum Switching Current	2 A	
	Maximum Carrying Current	2 A	
Minimum Contact	Ratings	10 m VDC, 10µA *1	
Initial Contact Re	sistance	75 m $\Omega$ max. (initial)	
Operate Time [Se	t Time] (Excluding bounce)	Approx. 2 ms [2ms]	
Release Time [Re	set Time] (Excluding bounce)	Approx. 1 ms [2ms] without diode	
Insulation Resista	ince	1000 M Ω at 500 VDC	
	Between open contacts	1000 VAC (for one minute) 1500 V surge (10x160 μs *2) [High breakdown voltage (NKX) type]	
		Make contact: 1500 VAC (for one minute) 2500 V surge (2x10 µs *3)	
Withstanding Voltage	Between adjacent contacts	Break contact: 1000 VAC (for one minute) 1500 V surge (10x160 μs *2) 1000 VAC (for one minute) 1500 V surge (10x160 μs *2)	
	Between coil and contacts	1500 VAC (for one minute), 2500 V surge (2x10 μs *3) [Double coil latch type] 1000 VAC (for one minute) 1500 V surge (10x160 μs *2)	
Shock Resistance	) }	735 m/s <sup>2</sup> (75G) (misoperation) 980 m/s <sup>2</sup> (100G) (destructive failure)	
Vibration Resista	nce	10 to 55 Hz, double amplitude 3 mm(20G) (misoperation) 10 to 55 Hz, double amplitude 5 mm(30G) (destructive failure)	
Ambient Tempera	ture	-40 to +85°C	
Coil Temperature	Rise	18°C at nominal coil voltage (140mW)	
Running	Nonload	1x10 <sup>8</sup> operations (Non-latch type) * <b>4</b> 1x10 <sup>7</sup> operations (latch type)	
Specifications	Load	50 VDC 0.1A (resistive), 1x10 <sup>6</sup> operations at 85°C ,5Hz 10 VDC 10mA (resistive), 1x10 <sup>6</sup> operations at 85°C ,2Hz	
Weight	1	Approx. 1.9 g	

\*1 This value is a reference value in the resistive load.

Minimum capacity changes depending on switching frequency and environment temperature and the load.

\*2 rise time: 10 µs, decay time to half crest: 160 µs

\*3 rise time: 2  $\mu s,$  decay time to half crest: 10  $\mu s$ 

\*4 This shows the number of operations with fatal defects. Stable characteristics are maintained for 1 × 10<sup>7</sup> operations.

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### **COIL SPECIFICATIONS**

### Non-latch Type

NEXEM

Non-latch Type	Ion-latch Type     at 20°C						
Nominal	Coil	Must Operate	Must Release	Nominal			
Coil Voltage	Resistance	Voltage*	Voltage*	Operating Power			
(VDC)	$(\Omega) \pm 10\%$	(VDC)	(VDC)	(mW)			
3	64.3	2.25	0.3	140			
4.5	145	3.38	0.45	140			
5	178	3.75	0.5	140			
9	579	6.75	0.9	140			
12	1028	9.0	1.2	140			
24	2880	18.0	2.4	200			

#### Single Coil Latch Type

Single Coil Latch Ty	Single Coil Latch Typeat 20°C						
Nominal	Coil	Set	Reset	Nominal			
Coil Voltage	Resistance	Voltage*	Voltage*	Operating Power			
(VDC)	$(\Omega) \pm 10\%$	(VDC)	(VDC)	(mW)			
3	90	2.25	2.25	100			
4.5	202.5	3.38	3.38	100			
5	250	3.75	3.75	100			
9	810	6.75	6.75	100			
12	1440	9.0	9.0	100			
24	5760	18.0	18.0	100			

Double Coil Latch T	<b>ype</b> (Can not b	e driven by	v reverse polarity	for reverse operation)	at 20°C

Nominal	Coil		Set	Reset	Nominal
Coil Voltage	Resis	tance	Voltage**	Voltage**	Operating Power
(VDC)	(Ω) ±	± 10%	(VDC)	(VDC)	(mW)
3	S	64.3	2.25	-	140
5	R	64.3	-	2.25	140
4.5	S	145	3.38	-	140
4.5	R	145	-	3.38	140
5	S	178	3.75	-	140
5	R	178	-	3.75	140
9	S	579	6.75	-	140
9	R	579	-	6.75	140
40	S	1028	9.0	-	140
12	R	1028	-	9.0	140
24	S	4114	18.0	-	140
24	R	4114	-	18.0	140

#### Non-latch High Insulation (ND) Type

Non-latch High Insu	on-latch High Insulation (ND) Type at 20°C					
Nominal	Coil	Must Operate	Must Release	Nominal		
Coil Voltage	Resistance	Voltage*	Voltage*	Operating Power		
(VDC)	$(\Omega) \pm 10\%$	(VDC)	(VDC)	(mW)		
3	45	2.25	0.3	200		
4.5	101	3.38	0.45	200		
5	125	3.75	0.5	200		
9	405	6.75	0.9	200		
12	720	9.0	1.2	200		
24	2504	18.0	2.4	230		

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at 20°C



### Single Coil Latch High Insulation (ND) Type

	J				
Nominal		Coil	Set	Reset	Nominal
	Coil Voltage	Resistance	Voltage*	Voltage*	Operating Power
	(VDC)	$(\Omega) \pm 10\%$	(VDC)	(VDC)	(mW)
	3	90	2.25	2.25	100
	4.5	203	3.38	3.38	100
	5	250	3.75	3.75	100
	9	810	6.75	6.75	100
	12	960	9.0	9.0	150
	24	3388	18.0	18.0	170

#### Non-latch High Breakdown Voltage (NKX) Type

at 20°C

J	J. (	/ <b>/</b>		
Nominal	Coil	Must Operate	Must Release	Nominal
Coil Voltage	Resistance	Voltage*	Voltage*	Operating Power
(VDC)	$(\Omega) \pm 10\%$	(VDC)	(VDC)	(mW)
3	39.1	2.25	0.3	230
4.5	88.0	3.38	0.45	230
12	626	9.0	1.2	230

Note \* Test by pulse voltage

\*\*S : Set coil (pin No.1 ... (+) , pin No.12 ...(-) ) R : Reset coil (pin No.6...(+) , pin No.7...(-) ) The latch type relays should be initialized at appointed position before using, and should be energized to specific polarity by above polarity to avoid wrong operation. Any special coil requirement, please contact EM Devices for availability.

#### SAFETY STANDARD AND RATING

UL Recognized	CSA Certificated TUV Certificate		
(UL508)*	(CSA C22.2 No14)	(IEC61810/ EN61810)	(EN61810)
File No E73266	File No LR46266	No. R 9750561	No. R 9751153
		ND Type	NU,NJ,NUH,NUX Type
30 VDC, 27	30 VDC, 2 A (Resistive) (Non-latch and Single coillatch) (Non-latch and Single c		(Non-latch and Single coillatch)
110 VDC, 0.3	BA (Resistive)	Creepage and clearance of coil to contact is more than 2 mm.	
125 VAC, 0.5 A (Resistive)		(According	to EN60950)
		Supplementary insulation class	Basic insulation class

\* Spacing: UL114, UL478

TUV Certificate				
(EN61810)				
No. R 9751153				
NU,NJ,NUH,NUX Type				
(Non-latch and Single coillatch)				
Creepage and clearance of coil to contact is more than 2 mm.				
(According to EN60950)				
Supplementary insulation class Basic insulation class				

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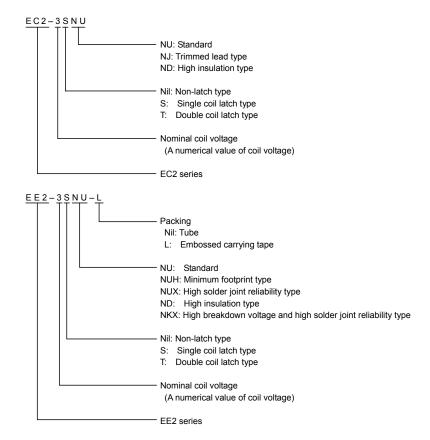


### **RECOMMENDED RELAY DRIVE CONDITIONS**

Drive under conditions. If it is impossible, please inquire to EM Devices.

Non-latch type	Voltage: within $\pm$ 5% of nominal voltage	
Single coil latch type Double coil latch type	Square pulse (rise and fall time is rapid) Pulse height : within $\pm5\%$ of nominal voltage Pulse width : More than 10 ms	Ambient temperature −40 to +85°C

#### PART NUMBER SYSTEM



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### **ORDERING PART NUMBERS**

### EC2 series

Opt	ion	Nominal		Coil Type		
Terminal	Packing	Coil Voltage (VDC)	Non-latch	Single Coil Latch	Double Coil Latch	
		3	EC2-3NU	EC2-3SNU	EC2-3TNU	
		4.5	EC2-4.5NU	EC2-4.5SNU	EC2-4.5TNU	
Standard		5	EC2-5NU	EC2-5SNU	EC2-5TNU	
Standard	Tube	9	EC2-9NU	EC2-9SNU	EC2-9TNU	
		12	EC2-12NU	EC2-12SNU	EC2-12TNU	
		24	EC2-24NU	EC2-24SNU	EC2-24TNU	
		3	EC2-3NJ	EC2-3SNJ	EC2-3TNJ	
		4.5	EC2-4.5NJ	EC2-4.5SNJ	EC2-4.5TNJ	
Trimmed lead		5	EC2-5NJ	EC2-5SNJ	EC2-5TNJ	
		9	EC2-9NJ	EC2-9SNJ	EC2-9TNJ	
		12	EC2-12NJ	EC2-12SNJ	EC2-12TNJ	
		24	EC2-24NJ	EC2-24SNJ	EC2-24TNJ	

#### □ EC2 series High Insulation Type (ND Type)

Option		Nominal	Coil Type		
Terminal	Packing	Coil Voltage (VDC)	Non-latch	Single Coil Latch	
Standard	Tube	3	EC2-3ND	EC2-3SND	
		4.5	EC2-4.5ND	EC2-4.5SND	
		5	EC2-5ND	EC2-5SND	
		9	EC2-9ND	EC2-9SND	
		12	EC2-12ND	EC2-12SND	
		24	EC2-24ND	EC2-24SND	

#### EE2 series

Option		Nominal	Coil Type				
Terminal	Packing	Coil Voltage (VDC)	Non-latch	Single Coil Latch	Double Coil Latch		
	3	EE2-3NU	EE2-3SNU	EE2-3TNU			
		4.5	EE2-4.5NU	EE2-4.5SNU	EE2-4.5TNU		
	Tube	5	EE2-5NU	EE2-5SNU	EE2-5TNU		
	Tube	9	EE2-9NU	EE2-9SNU	EE2-9TNU		
		12	EE2-12NU	EE2-12SNU	EE2-12TNU		
		24	EE2-24NU	EE2-24SNU	EE2-24TNU		
Standard		3	EE2-3NU-L	EE2-3SNU-L	EE2-3TNU-L		
	Taping	4.5	EE2-4.5NU-L	EE2-4.5SNU-L	EE2-4.5TNU-L		
		5	EE2-5NU-L	EE2-5SNU-L	EE2-5TNU-L		
		9	EE2-9NU-L	EE2-9SNU-L	EE2-9TNU-L		
		12	EE2-12NU-L	EE2-12SNU-L	EE2-12TNU-L		
		24	EE2-24NU-L	EE2-24SNU-L	EE2-24TNU-L		
	Tube	3	EE2-3NUH	EE2-3SNUH	EE2-3TNUH		
Minimum footprint		4.5	EE2-4.5NUH	EE2-4.5SNUH	EE2-4.5TNUH		
		5	EE2-5NUH	EE2-5SNUH	EE2-5TNUH		
		9	EE2-9NUH	EE2-9SNUH	EE2-9TNUH		
		12	EE2-12NUH	EE2-12SNUH	EE2-12TNUH		
		24	EE2-24NUH	EE2-24SNUH	EE2-24TNUH		

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Minimum Ta footprint		3	EE2-3NUH-L	EE2-3SNUH-L	EE2-3TNUH-L
		4.5	EE2-4.5NUH-L	EE2-4.5SNUH-L	EE2-4.5TNUH-L
	Toping	5	EE2-5NUH-L	EE2-5SNUH-L	EE2-5TNUH-L
	Taping	9	EE2-9NUH-L	EE2-9SNUH-L	EE2-9TNUH-L
		12	EE2-12NUH-L	EE2-12SNUH-L	EE2-12TNUH-L
		24	EE2-24NUH-L	EE2-24SNUH-L	EE2-24TNUH-L
		3	EE2-3NUX	EE2-3SNUX	EE2-3TNUX
High solder	Tube -	4.5	EE2-4.5NUX	EE2-4.5SNUX	EE2-4.5TNUX
		5	EE2-5NUX	EE2-5SNUX	EE2-5TNUX
		9	EE2-9NUX	EE2-9SNUX	EE2-9TNUX
		12	EE2-12NUX	EE2-12SNUX	EE2-12TNUX
		24	EE2-24NUX	EE2-24SNUX	EE2-24TNUX
joint reliability		3	EE2-3NUX-L	EE2-3SNUX-L	EE2-3TNUX-L
	Taping -	4.5	EE2-4.5NUX-L	EE2-4.5SNUX-L	EE2-4.5TNUX-L
		5	EE2-5NUX-L	EE2-5SNUX-L	EE2-5TNUX-L
		9	EE2-9NUX-L	EE2-9SNUX-L	EE2-9TNUX-L
		12	EE2-12NUX-L	EE2-12SNUX-L	EE2-12TNUX-L
		24	EE2-24NUX-L	EE2-24SNUX-L	EE2-24TNUX-L

#### EE2 series High Insulation Type (ND Type)

Option		Nominal	Coil Type		
Terminal	Packing	Coil Voltage (VDC)	Non-latch	Single Coil Latch	
	Tube	3	EE2-3ND	EE2-3SND	
		4.5	EE2-4.5ND	EE2-4.5SND	
		5	EE2-5ND	EE2-5SND	
Standard		9	EE2-9ND	EE2-9SND	
		12	EE2-12ND	EE2-12SND	
		24	EE2-24ND	EE2-24SND	
	Taping	3	EE2-3ND-L	EE2-3SND-L	
		4.5	EE2-4.5ND-L	EE2-4.5SND-L	
		5	EE2-5ND-L	EE2-5SND-L	
		9	EE2-9ND-L	EE2-9SND-L	
		12	EE2-12ND-L	EE2-12SND-L	
		24	EE2-24ND-L	EE2-24SND-L	

### EE2 series High Breakdown Voltage Type (NKX Type)

	-	• • •	•••
Op	tion	Nominal	Coil Type
Terminal	Packing	Coil Voltage (VDC)	Non-latch
High solder joint reliability	Tube	3	EE2-3NKX
		4.5	EE2-4.5NKX
		12	EE2-12NKX
	Taping	3	EE2-3NKX-L
		4.5	EE2-4.5NKX-L
		12	EE2-12NKX-L

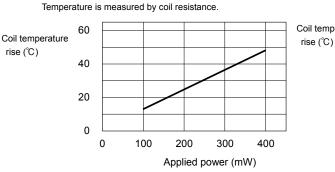
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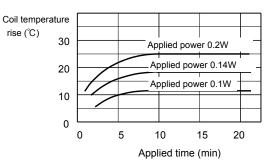
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#### PERFORMANCE DATA

NEXEM

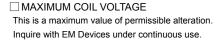
### □ COIL TEMPERATURE RISE

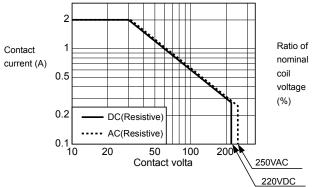


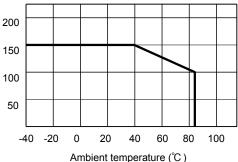


□ SWITCHING CAPACITY

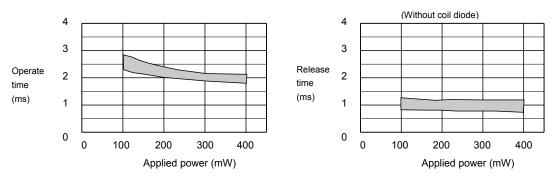
These are maximum value. Inquire with EM Devices for maximum values under continuous use.







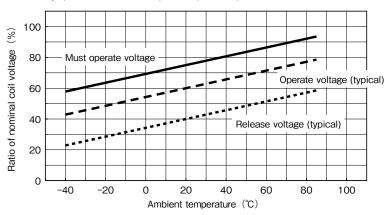
APPLIED POWER VS. TIMING (Sample:EC2-5NU)



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#### OPERATE AND RELEASE VOLTAGE VS. AMBIENT TEMPERATURE

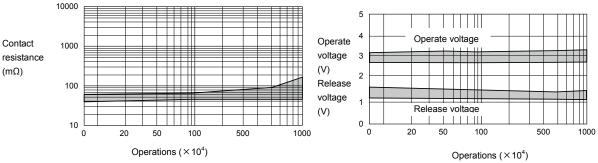
This shows a typical change of operate (release) voltage. The value of must operate is estimated, so coil voltage must be applied more than this value for safety operation. For hot start operation, please inquire with EM Devices.



RUNNING TEST (Non load)

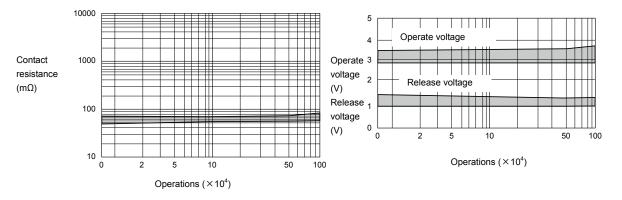
NEXEM

(Load: none, Drive:5VDC, 50Hz, 50%duty, Ambient temperature :room temperature, Sample:EC2-5NU, 20pieces)



□ RUNNING TEST(Load)

(Load:50VDC 0.1A resistive, Drive:5VDC, 5Hz, 50%duty, Ambient temperature:85°C, Sample:EC2-5NU, 10pieces)

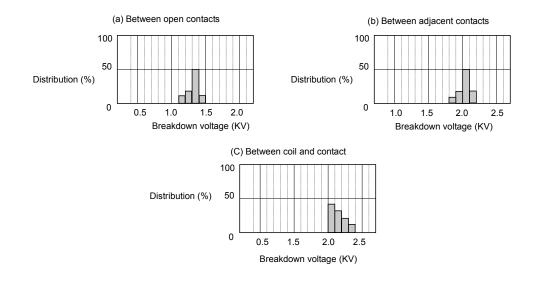


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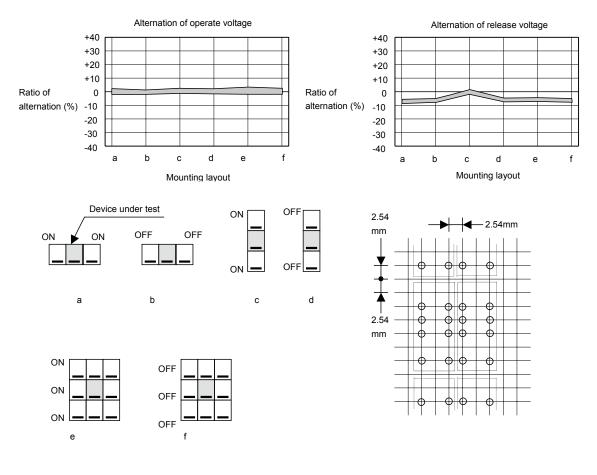


#### BREAKDOWN VOLTAGE

Sample: EC2-5NU 10peices



### □ ALTERNATION OF VOLTAGE IN DENSE MOUNTING (Magnetic interference)

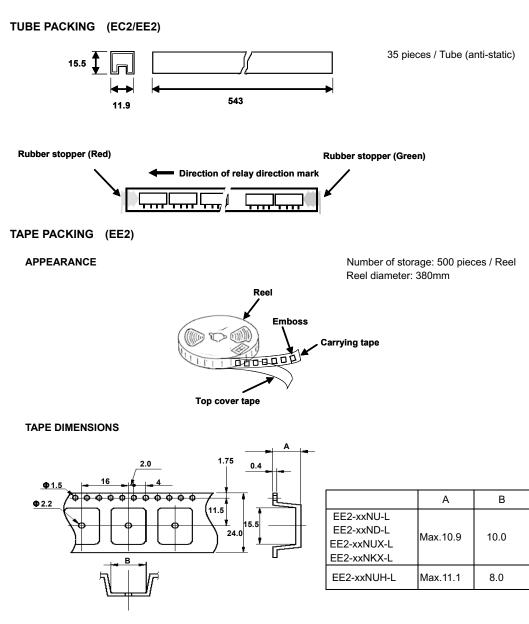


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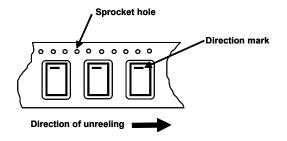
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### PACKING DIMENSION (Unit: mm)



#### RELAY DIRECTION MARK AND TAPE CARRYING DIRECTION



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#### SOLDERING TEMPERATURE CONDITION

#### **THROUGH-HOLE MOUNTING (EC2)**

1. Automatic soldering

Preheating: 110~ 120°C /110 s (max.) Solder temperature: 260°C max. Solder time: 5 s max.

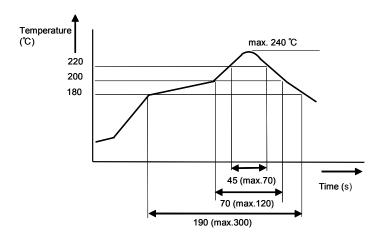
Note: EM Devices recommends cooling down a printed circuit board less than 110°C within 40 s after soldering.

#### 2. Manual soldering

Solder temperature: 350°C max. Solder time: 3 s max.

#### SURFACE-MOUNTING TYPE (EE2)

#### **IRS Method**



Note:

- 1. Temperature profile shows printed circuit board surface temperature on the relay terminal portion.
- 2. Check the actual soldering condition to use other method except above mentioned temperature profiles.

### NOTE ON CORRECT USE

#### 1. Notes on contact load

Make sure that the contact load is within the specified range;

otherwise, the lifetime of the contacts will be shortened considerably.

Note that the running performance shown is an example, and that it varies depending on parameters such as the type of load, switching frequency, driver circuit, and ambient temperature under the actual operating conditions.

Evaluate the performance by using the actual circuit before using the relay.

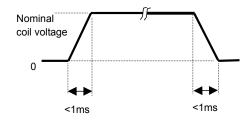
#### 2. Driving relays

- If the internal connection diagram of a relay shows + and symbols on the coil, apply the rated voltage to the relay in the specified direction. If a rippled DC current source is used, abnormalities such as beat at the coil may occur.

- The maximum voltage that can be applied to the coil of the relay varies depending on the ambient temperature.

Generally, the higher the voltage applied to the coil, the shorter the operating time. Note, however, that a high voltage also increases the bounce of the contacts and the contact opening and closing frequency, which may shorten the lifetime of the contacts.

- If the driving voltage waveform of the relay coil rises and falls gradually, the inherent performance of the relay may not be fully realized. Make sure that the voltage waveform instantaneously rises and falls as a pulse.



- For a latching relay, apply a voltage to the coil according to the polarity specified in the internal connection diagram of the relay.

 If a current is applied to the coil over a long period of time, the coil temperature rises, promoting generation of organic gas inside the relay, which may result in faulty contacts. In this case, use of a latching relay is recommended.

- The operating time and release time indicate the time required for each contact to close after the voltage has been applied to or removed from the coil. However, because the relay has a mechanical structure, a bounce state exists at the end of the operating and release times. Furthermore, because additional time is required until the contact stabilizes after being in a high-resistance state, care must be taken when using the relay at high speeds.

#### 3. Operating environment

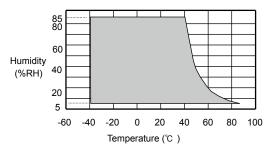
- Make sure that the relay mounted in the application set is used within the specified temperature range. Use of a relay at

a temperature outside this range may adversely affect insulation or contact performance.

- If the relay is used for a long period of time in highly humid (RH 85% or higher) environment, moisture may be absorbed into the relay. This moisture may react with the NOx and SOx generated by glow discharges that occur when the contacts are opened or closed, producing nitric or sulfuric acid. If this happens, the acid produced may corrode the metallic parts of the relay, causing operational malfunction.

- If any material containing silicone (silicone rubber, silicone oil, and silicone based coating material) is used in the neighborhood of relay, there is some possibility that these materials will emit silicone gas that will penetrate the relay. In this case, the switching contact may generate silicon compounds on the surface of contacts. This silicon compound may result in contact failure. Avoid use of relay in such an environment.

- Because the operating temperature range varies depending on the humidity, use the relay in the temperature range illustrated in the figure below. Prevent the relay from being frozen and avoid the generation of condensation.



- The relay maintains constant sealability under normal atmospheric pressure (810 to 1,200 hPa). Its sealability may be degraded or the relay may be deformed and malfunction if it is used under barometric conditions exceeding the specified range.

- The same applies when the relay is stored or transported. Keep the upper-limit value of the temperature to which the relay is exposed after it is removed from the carton box to within 50°C .

 Permanent magnets are used in polarized relays. For this reason, when magnets, transformers, or speakers are located nearby the relay characteristics may change and faulty operations may result.

- If excessive vibration or shock is applied to the relay, it may malfunction and the contacts remain closed. Vibration or shock applied to the relay during operation may cause considerable damage to or wearing of the contacts. Note that operation of a snap switch mounted close to the relay or shock due to the operation of magnetic solenoid may also cause malfunctioning.

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### EC2/EE2 SERIES

## NEXEM

#### 4. Notes on mounting relays

- When mounting a relay onto a PC board using an automatic chip mounter, if excessive force is applied to the cover of the relay when the relay is chucked or inserted, the cover may be damaged or the characteristics of the relay degraded. Keep the force applied to the relay to within 1 kg.

- Avoid bending the pins to temporarily secure the relay to the PC board. Bending the pins may degrade sealability or adversely affect the internal mechanism.

- It is recommended to solder the relay onto a PC board under the following conditions:

<1> Reflow soldering

Refer to the recommended soldering temperature profile.

<2> Flow soldering

Solder temperature: 260  $^\circ C$  max., Time: 5 s max.

Preheating: 110~ 120°C /110 s. (max.)

<3> Manual soldering

Solder temperature: 350°C , Time: 2~3 s

- Ventilation immediately after soldering is recommended. Avoid immersing the relay in cleaning solvent immediately after soldering due to the danger of thermal shock being applied to the relay.

- Use an alcohol-based or water-based cleaning solvent. Never use thinner and benzene because they may damage the relay housing.

 Do not use ultrasonic cleaning because the vibration energy generated by the ultrasonic waves may cause the contacts to remain closed.

5. Handling

- Relays are packaged in magazine cases for shipment. If a space is created in the case after some relays have been removed, be sure to insert a stopper to secure the remaining relays in the case. If relays are not well secured, vibration during transportation may cause malfunctioning of the contacts.

- Exercise care in handling the relay so as to avoid dropping it or allowing it to fall. Do not use a relay that has been dropped. If a relay drops from a workbench to the floor, a shock of 9,800 m/s<sup>2</sup> (1,000 G) or more is applied to the relay, possibly damaging its functions. Even if a light shock has been applied to the relay, thoroughly evaluate its operation before using it.

- Latching relays are factory-set to the reset state for shipment. A latching relay may be set, however, by vibration or shock applied while being transported. Be sure to forcibly reset the relay before using it in the application set. Also note that the relay may be set by unexpected vibration or shock when it is used in a portable set.

 The sealability of a surface-mount (SMT) relay may be lost if the relay absorbs moisture and is then heated during soldering.
 When storing relays, therefore, observe the following points:
 <1> For standard packing, please use relays within 12 months after delivery. (Storage conditions: 30°C / 60% RH)

If the relays have moisture absorption, dehumidify as follows.

Tape packing: 50  $\pm\,5^\circ\!\mathrm{C}$  , 200~300 h

Simple relay:  $85 \pm 5^{\circ}$ C , 48 h

<2> For MBB packing, please use relays within 2 years after

delivery.

(Storage conditions: 30°C / 60% RH)

After open MBB packing, please use within 3 months. (Storage conditions: 30°C / 60% RH)

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- Standard: Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots
- Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)
- Specific: Aircrafts, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

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